

LP3933 Lighting Management System for Six White LEDs and Two RGB or FLASH LEDs

General Description

The LP3933 is a complete lighting management system designed for portable wireless applications. It contains a boost DC/DC converter, 4 white-LED drivers to drive the main LCD panel backlight, 2 white-LED drivers for the sub-LCD panel and two sets of RGB/FLASH LED drivers.

Both backlight drivers have 8-bit constant current drivers that are separately adjustable and matched to 0.5% (typ.). The RGB LED drivers are PWM-driven with programmable color, intensity and blinking patterns. In addition, they feature a FLASH function to support picture taking with cameraenabled cellular phones.

An efficient magnetic boost DC/DC converter provides the required bias for LEDs, operating from a single Li-Ion battery. The DC/DC converter output voltage is user programmable from 4.1V to 5.3V for adapting to different LED types and for efficiency optimization. All functions are software controllable through a SPI interface and 19 internal registers.

Features

- High Efficiency Programmable 300 mA Magnetic Boost DC-DC converter
- 2 separately controlled PWM RGB LED drivers with programmable color, brightness, turn on/off slopes and blinking patterns
- FLASH function with up to 6 outputs, each up to 120 mA
- 4 constant current LED drivers with programmable 8-bit adjustment (0 … 25 mA/LED)
- 2 constant current LED drivers with programmable 8-bit adjustment (0 … 25 mA/LED)
- Functions software controlled through SPI interface
- Additional LED on/off and dimming hardware control
- Programmable low current Standby mode
- Low voltage digital interface down to 1.8V
- Space efficient 32-pin thin CSP laminate package

Applications

- Cellular Phones
- n PDAs

Note: The actual physical placement of the package marking will vary from part to part. The package marking "XY" designates the date code. "UZ" and "TT" are NSC internal codes for die manufacturing and assembly traceability. Both will vary considerably.

Ordering Information

Absolute Maximum Ratings (Notes 1,

2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Operating Ratings (Notes 1, 2)

Thermal Properties

Electrical Characteristics (Notes 2, [11\)](#page-4-0)

Limits in standard typeface are for T_J = 25°C. Limits in **boldface** type apply over the operating ambient temperature range (-40°C ≤ T_A ≤ +85°C). Unless otherwise noted, specifications apply to the LP3933 Functional Block Diagram (pg. 5) with: V_{DD1} $= V_{DD2} = 2.775V$, $C_{VDD1} = C_{VDD2} = C_{VDD10} = 0.1 \text{ }\mu\text{F}$, $C_{OUT} = C_{IN} = 10 \text{ }\mu\text{F}$, $C_{VREF} = 0.1 \text{ }\mu\text{F}$, $L_1 = 10 \text{ }\mu\text{H}$ [\(Note 12\).](#page-4-0)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the component may occur. Operating Ratings are conditions under which operation of the device is guaranteed. Operating Ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics tables.

Note 2: All voltages are with respect to the potential at the GND pins (GND1-4, GND_BOOST, GND_WLED, GND_RGB).

Note 3: Battery/Charger voltage should be above 6V no more than 10% of the operational lifetime.

Note 4: Voltage tolerance of LP3933 above 6.0V relies on fact that V_{DD1} and V_{DD2} (2.775V) are available (ON) at all conditions. If V_{DD1} and V_{DD2} are not available (ON) at all conditions, National Semiconductor does not guarantee any parameters or reliability for this device.

Note 5: The total load current of the boost converter should be limited to 300 mA.

Note 6: Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at $T_J = 160^{\circ}C$ (typ.) and disengages at $T_J = 160^{\circ}C$ 140˚C (typ.).

Note 7: For detailed soldering specifications and information, please refer to National Semiconductor Application Note 1125: Laminate CSP/FBGA.

Note 8: The Human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin. MIL-STD-883 3015.7

Electrical Characteristics (Notes [2,](#page-3-0) 11) (Continued)

Note 9: In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature $(T_{A\text{-MAX}})$ is dependent on the maximum operating junction temperature $(T_{J\text{-MAX-OP}} = 125^\circ C)$, the maximum power dissipation of the device in the application (P_{D-MAX}), and the junction-to ambient thermal resistance of the part/package in the application (θ_{JA}), as given by the following equation: $T_{A\text{-MAX}} = T_{J\text{-MAX-OP}} - (\theta_{JA} \times P_{D\text{-MAX}})$.

Note 10: Junction-to-ambient thermal resistance is highly application and board-layout dependent. In applications where high maximum power dissipation exists, special care must be paid to thermal dissipation issues in board design.

Note 11: Min and Max limits are guaranteed by design, test, or statistical analysis. Typical numbers are not guaranteed, but do represent the most likely norm. **Note 12:** Low-ESR Surface-Mount Ceramic Capacitors (MLCCs) are used in setting electrical characteristics.

Note 13: V_{REF} pin (Bandgap reference output) is for internal use only. A capacitor should always be placed between V_{REF} and GND1.

Note 14: ESD susceptibility for pin 11 and 12 is 500V for the human body model and 150V for the machine model.

Block Diagram

Modes of Operation

RESET: In the RESET mode all the internal registers are reset to the default values (Boost output register 3Fh (5.0V), all other registers 00h). Reset is entered always if input NRST is LOW or internal Power On Reset is active.

STANDBY: The STANDBY mode is entered if the register bit NSTBY is LOW and Reset is not active. This is the low power consumption mode, when all circuit functions are disabled. Registers can be written in this mode and the control bits are effective immediately after start up.

STARTUP: INTERNAL STARTUP SEQUENCE powers up all the needed internal blocks (V_{REF}, Bias, Oscillator etc.). To ensure the correct oscillator initialization, a 10 ms delay is generated by the internal state-machine. Thermal shutdown (THSD) disables the chip operation and Startup mode is entered until *no* thermal shutdown event is present.

BOOST STARTUP: Soft start for boost output is generated in the BOOST STARTUP mode. In this mode the boost output is raised in PFM mode during the 10 ms delay generated by the state-machine. The Boost startup is entered from Internal Startup Sequence if EN_BOOST is HIGH or from Normal mode when EN_BOOST is written HIGH.

NORMAL: During NORMAL mode the user controls the chip using the *Control Registers*. The registers can be written in any sequence and any number of bits can be altered in a register in one write.

Logic Interface Characteristics

 $(1.8V \le V_{DD_IO} \le V_{DD1,2})$

SPI Interface

LP3933 is compatible with the SPI serial bus specification and it operates as a slave. The transmission consists of 16-bit Write and Read Cycles. One cycle consists of 7 Address bits, 1 Read/Write (R/W) bit and 8 Data bits. R/W bit high state defines a Write Cycle and low defines a Read Cycle. SO output is normally in high-impedance state and it is active only when Data is sent out during a Read Cycle. A pull-up or pull-down resistor may be needed in SO line, if a

floating logic signal can cause unintended current consumption in the input where SO is connected. The Address and Data are transmitted MSB first. The Slave Select signal SS must be low during the Cycle transmission. SS resets the interface when high and it has to be taken high between successive Cycles. Data is clocked in on the rising edge of the SCK clock signal, while data is clocked out on the falling edge of SCK.

SPI Timing Parameters

 $V_{DD1,2} = V_{DD_IO} = 2.775V$

Note: Data guaranteed by design.

Magnetic Boost DC/DC Converter

The LP3933 boost DC/DC Converter generates 4.1V–5.3V supply voltage for the LEDs from single Li-Ion battery (3V…4.5V). The output voltage is controlled with 8-bit register in 9 steps. The converter is a magnetic switching PWM mode DC/DC converter with a current limit. The converter has 1 MHz switching frequency when timing resistor RT is 82 KΩ.

The topology of the magnetic boost converter is called CPM control, current programmed mode, where the inductor current is measured and controlled with the feedback. The user can program the output voltage of the boost converter. The control changes the resistor divider in the feedback loop.

The following figure shows the boost topology with the protection circuitry. Three different protection schemes are implemented:

- 1. Over voltage protection, limits the maximum output voltage
	- Keeps the output below breakdown voltage.
	- Prevents boost operation if battery voltage is much higher than desired output.
- 2. Over current protection, limits the maximum inductor current
	- Voltage over switching NMOS is monitored, too high voltages turn the switch off.
- 3. Duty cycle limiting, done with digital control.

Boost Standby Mode

User can set the Boost Converter to STANDBY mode by writing the register bit EN_BOOST low. When EN_BOOST is written high, the converter starts for 10 ms in PFM mode and then goes to PWM mode.

LP3933

Boost Output Voltage Control

User can control the boost output voltage by boost output 8-bit register.

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Boost Converter Typical Performance Characteristics $V_{IN} = 3.6V$, $V_{OUT} = 5.0V$ if not otherwise stated.

1400 1300 1200

Boost Converter Typical Performance Characteristics $V_{IN} = 3.6V$, $V_{OUT} = 5.0V$ if not otherwise stated. (Continued)

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Boost Line Regulation Boost Load Regulation, 50 mA–100 mA

Dual RGB LED Driver

The RGB driver has six outputs that can independently drive 2 separate RGB LEDs or six LEDs of any kind. User has control over the following parameters separately for each LED:

- **• ON and OFF** (start and stop time in blinking cycle)
- **• DUTY** (PWM brightness control)
- **• SLOPE** (turn-on and turn-off slope)
- **• ENABLE** (output enable control)

The main blinking cycle is controlled with 2-bit CYCLE control (0.25 / 0.5 / 1.0 / 2.0s).

RGB_START is the master enable control for the whole RGB function. The internal PWM and blinking control can be disabled by setting the RGB_PWM control LOW. In this case the individual enable controls can be used to switch outputs on and off. PWM_LED input can be used for external hardware PWM control.

In the normal PWM mode the R, G and B switches are controlled in 3 phases (one phase per driver). During each phase the peak current set by external resistor is driven through the LED for the time defined by DUTY setting (0 µs–50 µs). As a time averaged current this means 0%–33% of the peak current. The PWM period is 150 µs and the pulse frequency is 6.7 kHz in normal mode.

Normal Mode PWM Waveforms at Different Duty Settings

In the FLASH mode all the outputs are controlled in one phase and the PWM period is 50 µs. The time averaged FLASH mode current is three times the normal mode current at the same DUTY value.

Blinking can be controlled separately for each output. On and OFF times determine, when a LED turns on and off within the blinking cycle. When both ON and OFF are 0, the LED is on and doesn't blink. If ON equals OFF but is not 0, the LED is permanently off.

Example Blinking Waveforms

RGB Driver Electrical Characteristics

RGB LED PWM Control [\(Note 15\)](#page-13-0)

PWM_LED input can be used as direct on/off or brightness (PWM) control. If PWM_LED input is not used, it must be tied to V_{DD_IO}. **Note 15:** Application Note 1291, "Driving RGB LEDs Using LP3933 Lighting Management System" contains a thorough description of the RGB driver functionality including programming examples.

WLED Driver (WLED1...4)

White LED (WLED) driver drives each white LED with a regulated constant current. The amount of the current is controlled by the 8-bit current mode DAC from 0 to 25.5mA in 0.1mA steps.

CLED Driver (CLED1…2)

The current of CLEDs (Caller ID display backlight LEDs) can be adjusted by 8-bit current mode DAC. WLED and CLED can be used to drive any kind of LED.

Enables

WLED and CLED enable is controlled from user register. PWM control of WLED and CLED (for dimming etc.) is possible using PWM_LED pin together with WLED_PWM and CLED_PWM enable control from user register.

WLED and CLED Driver Electrical Characteristics

Note 16: A minimum voltage, Dropout Voltage, is required on the WLED and CLED outputs for maintaining the LED current. The current reduction at lower voltages is shown in the graph *WLED Output Current vs Voltage*

Note 17: Match % = 100% * (Max − Min)/Min

Adjustment

$WLED[7:0]$ or CLED[7:0]	WLED or CLED Current (Typical)	Units
0000 0000		mA
0000 0001	0.1	mA
0000 0010	0.2	mA
0000 0011	0.3	mA
1111 1101	25.3	mA
1111 1110	25.4	mA
1111 1111	25.5	mA

WLED or CLED Output Current vs Voltage Temperatures −40˚C, 25˚C, 85˚C, 100˚C

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Recommended External Components

OUTPUT CAPACITOR, COUT

The output capacitor C_{OUT} directly affects the magnitude of the output ripple voltage. In general, the higher the value of C_{OUT} , the lower the output ripple magnitude. Multilayer ceramic capacitors with low ESR are the best choice. At the lighter loads, the low ESR ceramics offer a much lower V_{OUT} ripple than the higher ESR tantalums of the same value. At the higher loads, the ceramics offer a slightly lower V_{OUT} ripple magnitude than the tantalums of the same value. However, the dv/dt of the V_{OUT} ripple with the ceramics is much lower than the tantalums under all load conditions. Capacitor voltage rating must be sufficient, 10V is recommended.

INPUT CAPACITOR, C_{IN}

The input capacitor C_{1N} directly affects the magnitude of the input ripple voltage and to a lesser degree the V_{OUT} ripple. A higher value C_{1N} will give a lower V_{1N} ripple. Capacitor voltage rating must be sufficient, 10V is recommended.

OUTPUT DIODE, DOUT

A Schottky diode should be used for the output diode. To maintain high efficiency the average current rating of the schottky diode should be larger than the peak inductor current (1A). Schottky diodes with a low forward drop and fast switching speeds are ideal for increasing efficiency in portable applications. Choose a reverse breakdown of the schottky diode larger than the output voltage. Do not use ordinary rectifier diodes, since slow switching speeds and long recovery times cause the efficiency and the load regulation to suffer.

INDUCTOR, L

The LP3933's high switching frequency enables the use of the small surface mount inductor. A 10 µH shielded inductor is suggested. Values below 4.7 µH should not be used. The inductor should have a saturation current rating higher than the peak current it will experience during circuit operation (\sim 1A). Less than 300 mΩ ESR is suggested for high efficiency. Open core inductors cause flux linkage with circuit components and interfere with the normal operation of the circuit. This should be avoided. For high efficiency, choose an inductor with a high frequency core material such as ferrite to reduce the core losses. To minimize radiated noise, use a toroid, pot core or shielded core inductor. The inductor should be connected to the SW pin as close to the IC as possible. Examples of suitable inductors are TDK types LLF4017T-100MR90C and VLF4012AT-100MR79 and Coilcraft type DO3314T-103.

LP3933

Recommended External Components (Continued)

List of Recommended External Components

Note 18: Resistor RT tolerance change will change the timing accuracy of RGB block. Also the boost converter switching frequency will be affected.

Control Registers

Control registers and register bits are shown in the following table.

Default value of each register is 0000 0000 except boost output which is 0011 1111 = 3Fh (5V).

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